

1 Scope

The present specifications shall apply to FM2-2202.

2 Outline

High Frequency Rectification

Type	Silicon Diode
Structure	Resin Molded
Applications	High Frequency Rectification

3 Flammability

UL94V-0(Equivalent)

4 Absolute maximum ratings

No.	Item	Symbol	Unit	Rating	Conditions
1	Transient Peak Reverse Voltage	V_{RSM}	V	200	
2	Peak Reverse Voltage	V_{RM}	V	200	
3	Average Forward Current	$I_{F(AV)}$	A	20	Refer to derating curve in Section 7
4	Peak Surge Forward Current	I_{FSM}	A	110	10ms. Half sine wave, one shot
5	I^2t Limiting Value	I^2t	A^2s	60.5	$1ms \leq t \leq 10ms$
6	Junction Temperature	T_j	°C	-40 to +150	
7	Storage Temperature	T_{stg}	°C	-40 to +150	

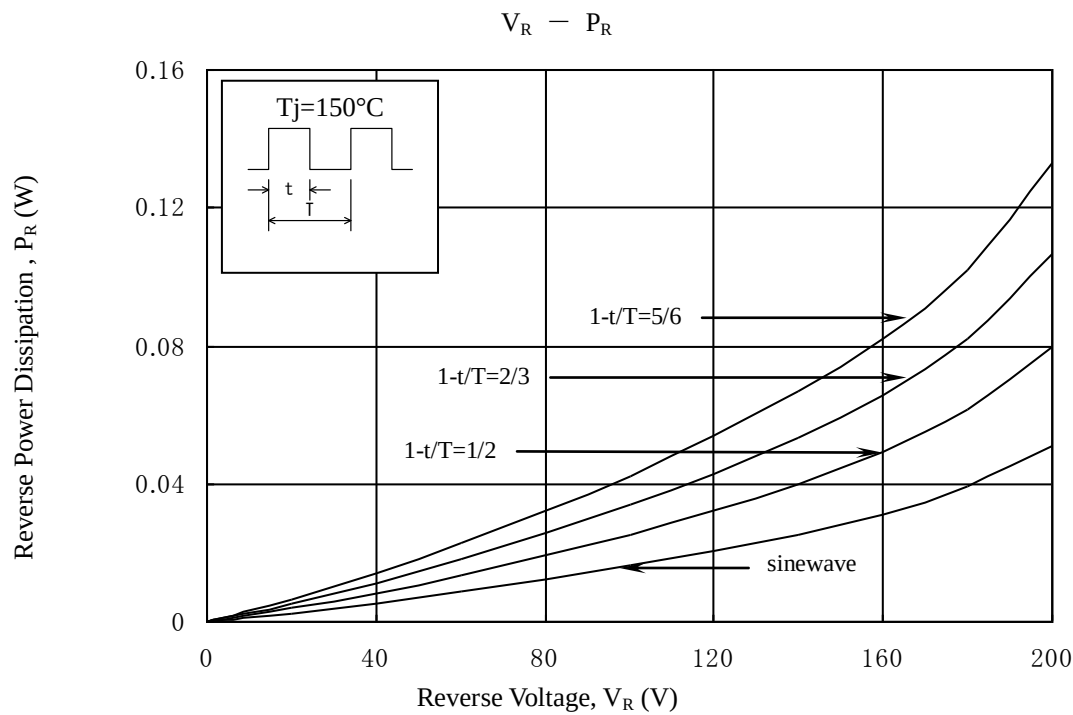
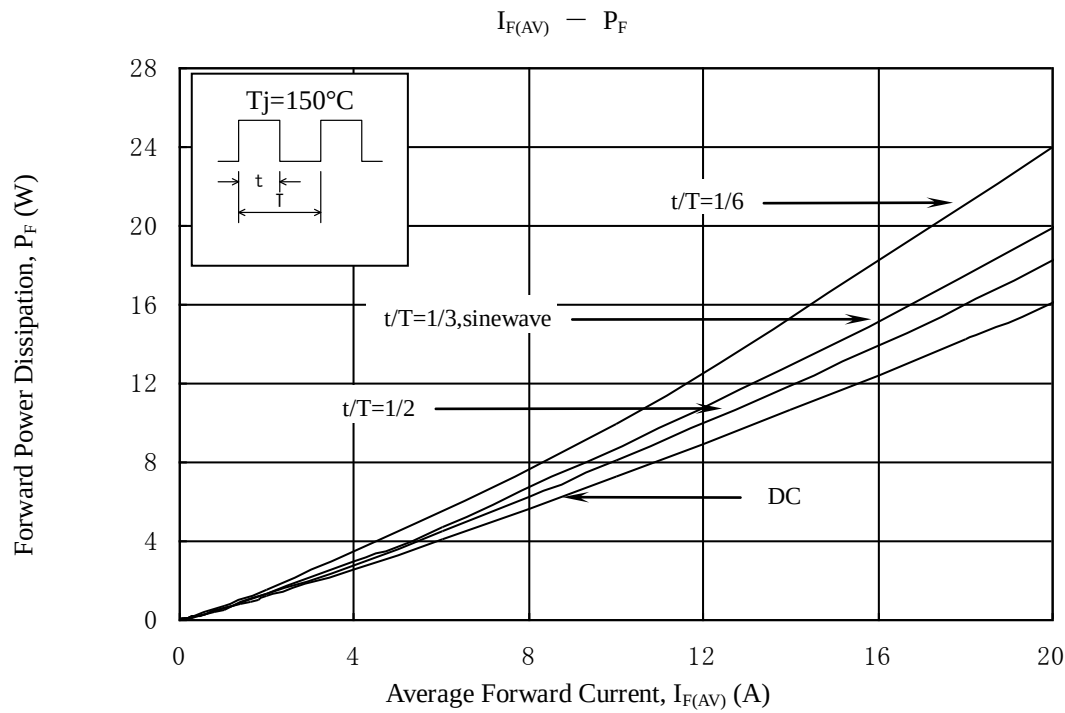
No.1,2,4 and 5 show ratings per one chip.

5 Electrical characteristics

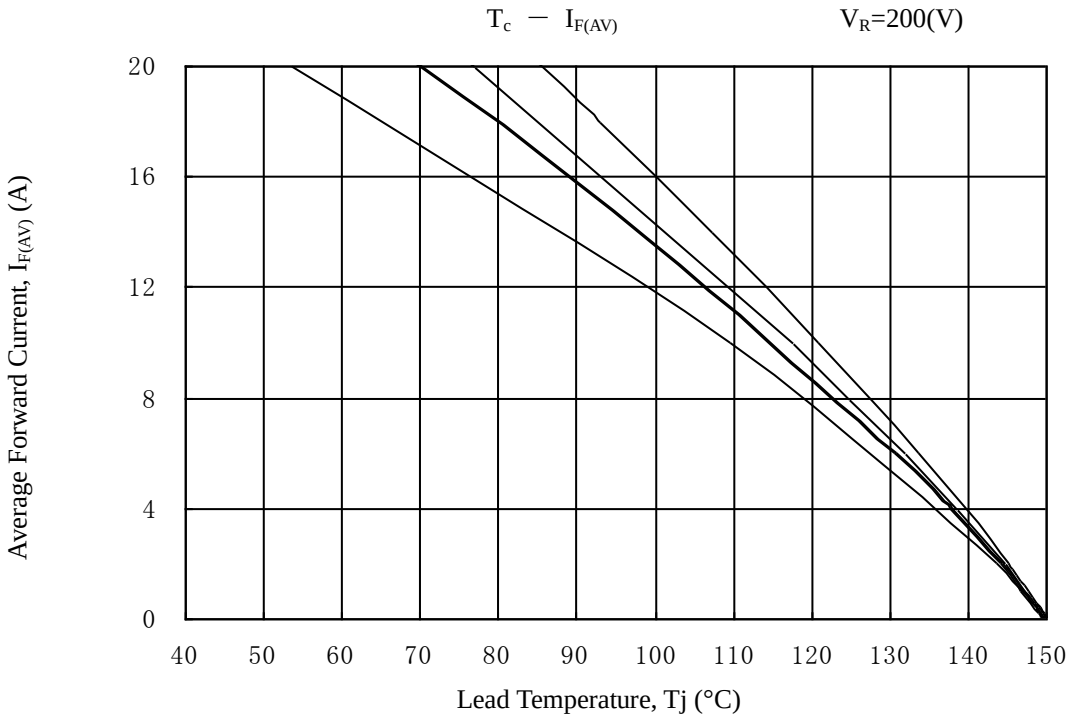
No.	Item	Symbol	Unit	Rating	Conditions
1	Forward Voltage Drop	V_F	V	0.98 max.	$I_F=10A$
2	Reverse Leakage Current	I_R	μA	200 max.	$V_R=V_{RM}$
3	Reverse Leakage Current Under High Temperature	$H \cdot I_R$	μA	400 max.	$V_R=V_{RM}$, $T_j=150^\circ C$
4	Reverse Recovery Time	trr1	ns	50 max.	$I_F=I_{RP}=100mA$ 90% Recovery point, $T_j=25^\circ C$
		trr2	ns	35 max.	$I_F=100mA$, $I_{RP}=200mA$ 75% Recovery point, $T_j=25^\circ C$
5	Thermal Resistance	$R_{th(j-c)}$	°C/W	4.0 max.	Between Junction and case

No.1,2,3 and 4 show characteristics per one chip.

6 Characteristics

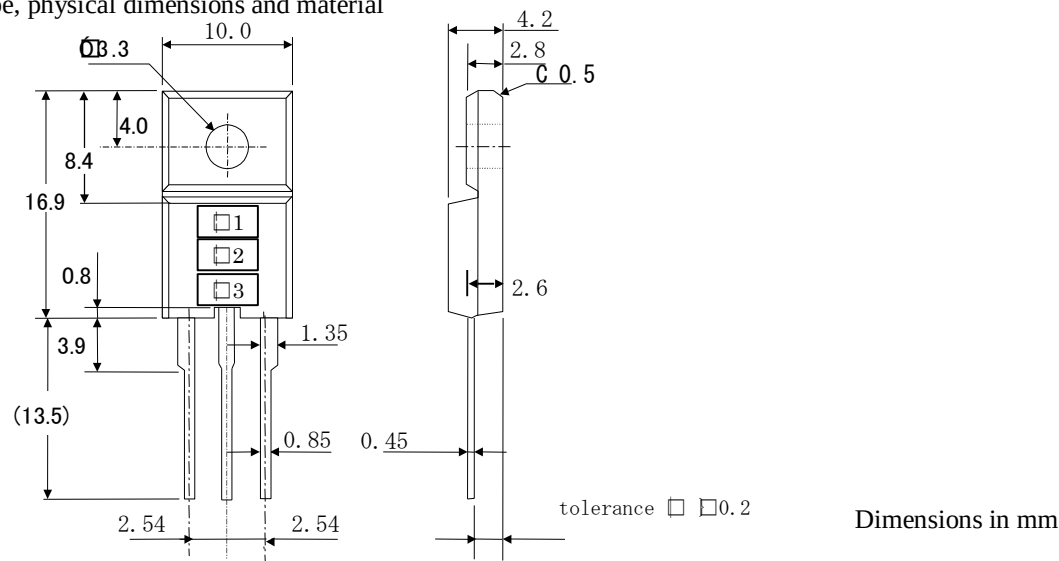


7 Derating



8 Package information

8-1Package type, physical dimensions and material



8-2Appearance

The body shall be clean and shall not bear any stain, rust or flaw.

8-3Marking

Type Name	Marking		
	*1 is type name	*2 is polarity	*3 is lot number
FM2-2202	22202		1st letter: Last digit of year 2nd letter: Month From 1 to 9 for Jan. to Sep., O for Oct., N for Nov., D for Dec. 3rd & 4th letter: Day ex. 3212 (February 12, 2003)